

INTERNATIONAL STANDARD

NORME INTERNATIONALE



Industrial communication networks – Fieldbus specifications –
Part 4-19: Data-link layer protocol specification – Type 19 elements

Réseaux de communication industriels – Spécifications des bus de terrain –
Partie 4-19: Spécification du protocole de la couche liaison de données –
Eléments de type 19

<https://standards.iteh.ai/xotilp/standards/isc/12ed470c-ca92-4f1e-b6fa-68d70ffac290/iec-61158-4-19-2014>



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IEC 61158-4-19

Edition 3.0 2014-08

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INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

COMMISSION
ELECTROTECHNIQUE
INTERNATIONALE

PRICE CODE
CODE PRIX

XH

ICS 25.040.40; 35.100.20; 35.110

ISBN 978-2-8322-1727-6

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